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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	:	
	:	
Hideki IWAKI	:	Confirmation No. 8158
	:	
Application No. 09/994,683	:	TC/Art Unit: 2826
	:	
Filed: November 28, 2001	:	Examiner: Leonardo Andujar
	:	
For: MULTI-LEVEL CIRCUIT SUBSTRATE,	:	Atty Docket: P94916US1
METHOD FOR MANUFACTURING	:	
SAME AND METHOD FOR	:	
ADJUSTING A CHARACTERISTIC	:	
IMPEDANCE THEREFOR	:	

LETTER RESPONDING TO COMMUNICATION

MAIL STOP ISSUE FEE
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Communication dated May 27, 2004, please cancel the sheet of drawings containing Figure 14 and the duplicate copy of Figure 9.

Should any questions arise, a representative of the Publishing Division is invited to call Applicant's undersigned counsel so that this case may proceed to issue.

Respectfully submitted,

JACOBSON HOLMAN PLLC

Date: June 3, 2004

By: Nathaniel A. Humphries

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